# PTCTT Series



**Vishay BCcomponents** 

# **TWIN Vertical SMD PTC Thermistors** For Telecom Overload Protection



QUICK REFERENCE DATA					
PARAMETER	VALUE	UNIT			
Resistance value at 25 °C	10 to 50	Ω			
Switching temperature	105 to 130	°C			
Maximum voltage (RMS)	240	V <sub>RMS</sub>			
Maximum overload current	2.5 to 8.0	А			
Operating temperature range at V <sub>max.</sub>	-40 to 85	°C			
Maximum trip time at 1 A	1.2 to 4.0	S			
Weight	~ 1.3	g			

### DESCRIPTION

The component consists of two high performance PTC ceramics mounted together on an alumina spacer cover and with 4 lead (Pb)-free tin plated contacts. The terminations are joined to the Ag plated ceramics by a high melting solder.

### MARKING

• All TWIN Vertical SMD PTC's are marked with the last 3-digits of the type number (BCxxx) and a date code (YYWW)

### **FEATURES**

· Very small footprint, allowing to increase the number of lines per PCB



- RoHS · Matched pairs in one component, significantly COMPLIANT reducing the assembly time
- Narrow tracking between the 2 PTC's over a wide temperature range (matching at 85 °C: ≤ 2 x matching at 25 °C)
- Limited height and weight, used on high speed pick-andplace circuit assembly
- Flat pick-up ceramic area for easy placement
- Small ceramics for faster response time
- Thermal coupled PTC's for enhanced protection
- Small and large pitch available
- · Compliant with the enhanced level requirements of ITU - K20-21-45 edition 2003
- · Suitable for lead (Pb)-bearing and lead (Pb)-free reflow soldering
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

Over-temperature/over-load protection:

- Telecom
  - Telecommunications infrastructure
  - PABX
  - Set-top Box (S.B.)

### MOUNTING

A flat pick-up area of 30 mm<sup>2</sup> and low weight allows for fast placement. No excessive solder paste should be used as no solder or flux can reach the ceramic body during reflow soldering. Not suitable for bismuth containing solder. Typical soldering

235 °C, duration: 5 s (Lead (Pb)-bearing) 245 °C, duration: 5 s (Lead (Pb)-free) Resistance to soldering heat 260 °C, duration: 10 s max.

ELECTRICAL DATA										
		I <sub>nt</sub> at			MAX.	I <sub>max.</sub>	I <sub>res</sub>			
± 20 % (Ω)	MATCHING (Ω)	V <sub>max.</sub> (V <sub>RMS</sub> )	25 °C (mA)	70 °C (mA)	85 °C (mA)	I <sub>t</sub> (mA)	TRIP-TIME at 1 A (s)	at V <sub>max.</sub> (A)	(2 PIECES POWERED) at V <sub>max.</sub> (mA)	
10	0.5	240	140	85	55	300	4.0	4.0	12.0	
20	0.5	240	90	60	40	200	2.0	8.0	12.0	
25	0.5	240	100	60	40	200	2.0	4.0	12.0	
35	1.0	240	100	60	40	200	1.5	4.0	12.0	
50	1.0	240	90	50	35	190	1.2	2.5	12.0	

#### Note

All data is measured at 25 °C unless otherwise specified

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1 For technical questions, contact: nlr@vishay.com



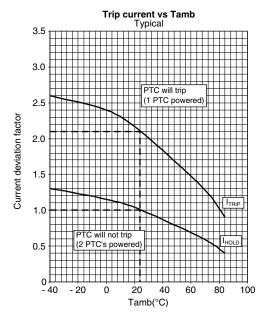
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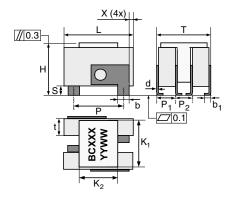
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ORDERING INFORMATION					
R <sub>25</sub> ± 20 %	SAP CC	DDING			
(Ω)	SMALL PITCH	LARGE PITCH			
10	PTCTT95R100GTE	PTCTT95R100GTELAR			
20	PTCTT95R200GTE	PTCTT95R200GTELAR			
25	PTCTT95R250GTE	PTCTT95R250GTELAR			
35	PTCTT95R350GTE	PTCTT95R350GTELAR			
50	PTCTT95R500GTE	PTCTT95R500GTELAR			

### **ELECTRICAL CHARACTERISTICS**



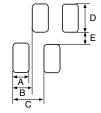
### **PTC OUTLINES**



DIMENSIONS in millimeters					
	SMALL PITCH	LARGE PITCH			
L	9.0 ± 0.1	9.0 ± 0.1			
Т	$7.2 \pm 0.25$	8.4 ± 0.25			
Н	$6.9 \pm 0.25$	6.9 ± 0.25			
b	1.5 ± 0.1	1.5 ± 0.1			
b <sub>1</sub>	0.9 ± 0.15	0.9 ± 0.15			
S	1.25 ± 0.15	1.25 ± 0.15			
d	0.22 ± 0.025	0.22 ± 0.025			
t	2.3 ± 0.1	2.3 ± 0.1			
Р	$6.5 \pm 0.5$	6.5 ± 0.5			
P <sub>1</sub>	2.55 ± 0.15	2.55 ± 0.15			
P <sub>2</sub>	2.2 ± 0.1	3.45 ± 0.15			
Х	$0.5 \pm 0.2$	0.5 ± 0.2			
K <sub>1</sub>	$6.0 \pm 0.5$	$7.2 \pm 0.5$			
K <sub>2</sub>	$5.0 \pm 0.5$	$5.0 \pm 0.5$			

<b>RECOMMENDED FOOTPRINT</b> in millimeters					
	SMALL PITCH LARGE PITCH				
A	2.0	2.0			
В	2.4	2.4			
С	3.8	5.0			
D	3.8	4.0			
E	2.7	1.4			

FOOTPRINT



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2 For technical questions, contact: nlr@vishay.com Document Number: 29088

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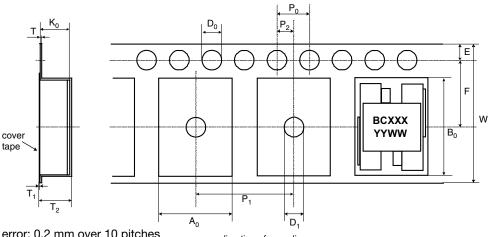
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### PACKAGING

### **Tape specifications**

All tape and reel specifications are in accordance with IEC 60286-3. Carrier tape material is non-conductive polystyrene or polycarbonate.

Blister tape



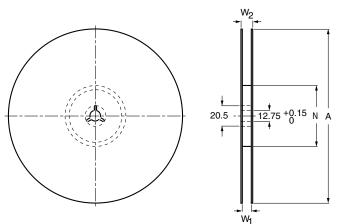
Cumulative pitch error: 0.2 mm over 10 pitches Cumulative tolerance over 10 holes:  $\pm$  0.2 mm

direction of unreeling

DIMENSIONS OF BLISTER TAPE in millimeters						
	SMALL PITCH	LARGE PITCH		SMALL PITCH	LARGE PITCH	
A <sub>0</sub>	7.2 ± 0.1	8.4 ± 0.1	D <sub>1</sub>	1.5 + 0.1	1.5 + 0.1	
B <sub>0</sub>	9.3 ± 0.1	9.3 ± 0.1	P <sub>0</sub>	4.0 ± 0.1	4.0 ± 0.1	
K <sub>0</sub>	7.2 ± 0.1	7.2 ± 0.1	P <sub>1</sub>	12.0 ± 0.1	12.0 ± 0.1	
W	$16.0 \pm 0.3$	$16.0 \pm 0.3$	P <sub>2</sub>	2.0 ± 0.1	2.0 ± 0.1	
Е	1.75 ± 0.1	1.75 ± 0.1	Т	$0.5 \pm 0.05$	0.5 ± 0.05	
F	7.5 ± 0.1	7.5 ± 0.1	T <sub>1</sub>	0.05	0.05	
D <sub>0</sub>	1.5 + 0.1	1.5 + 0.1	T <sub>2</sub>	7.8 max.	7.8 max.	

### **REEL SPECIFICATIONS** in millimeters

Reel



REEL DIMENSIONS in millimeters						
UNITS PER REEL	TAPE WIDTH	Α	Ν	<b>W</b> <sub>1</sub>	W <sub>2</sub> MAX.	
1 000	16	380	64	16.4	20.4	

#### Note

• Reels are packed in sealed plastic bags for protection against high humidity and corrosive atmospheres

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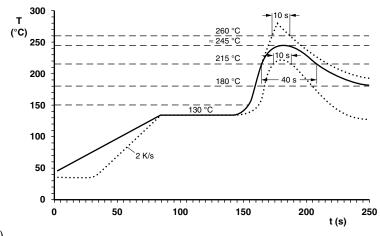
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### **SOLDERING CONDITIONS**

This SMD thermistor is only suitable for reflow soldering, in accordance with JEDEC J-STD-020. Soldering processes which can be used are reflow (infrared and convection heating) and vapour phase. The maximum temperature of 260 °C during 10 s should not be exceeded and no liquid flux should be allowed to reach the ceramic body.

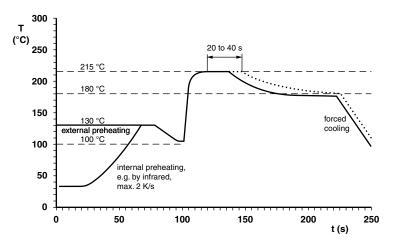
Typical examples of soldering processes that will provide reliable joints without damage, are shown below.

Reflow soldering



Typical values (solid line) Process limits (dotted lines)

Vapour phase soldering



Typical values (solid line) Process limits (dotted line)

### HANDLING PRECAUTIONS

Because of the nature of PTC ceramic material the component should not be touched with bare hands, as the residue of perspiration can influence component behaviour at high temperatures.

Handling forces applied to the component should be limited to 5 N in any condition.

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